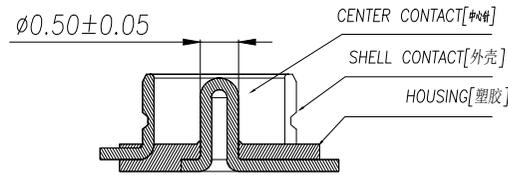
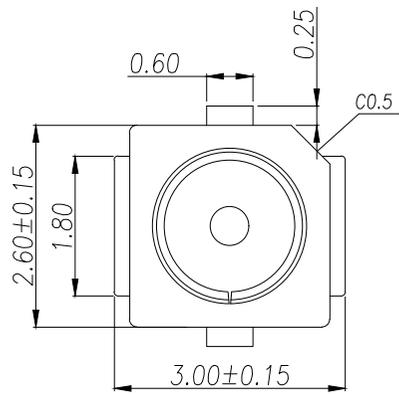
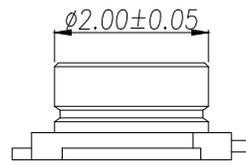
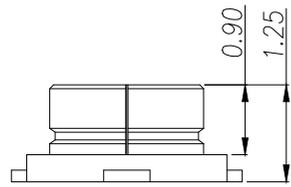


REV.	DESCRIPTION	ECN NO.	NAME	DATE

1



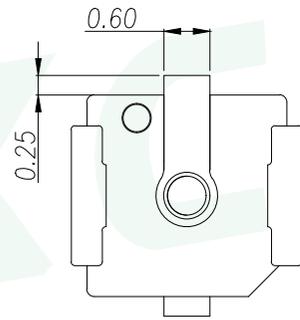
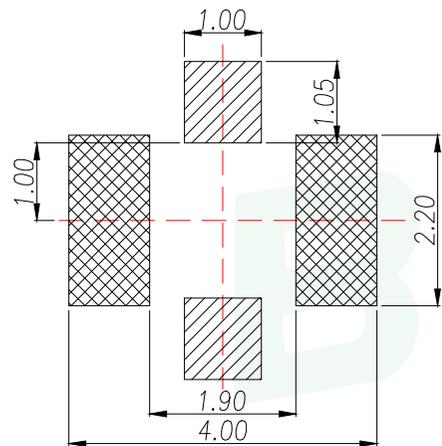
2



NOTES

- 1.0. RATING(????):
 - 1.1. VOLTAGE(???): 60 VAC (R.M.S.)
 - 1.2. NOMINAL CHARACTERISTIC IMPEDANCE(????): 50 Ohm
 - 1.3. APPLICABLE FREQUENCY(????): DC ~ 6GHz
 - 1.4. VSWR(????): 1.3 MAX. (DC~3GHz), 1.5 MAX. (3~6GHz)
 - 1.5. TEMPERATURE(????): -40°C TO +85°C
 - 1.6. APPLIED TO IR SOLDERING PROCESS(????)?
- 2.0. MATERIAL SEE BILL OF MATERIAL (????):
 - 2.1. HOUSING(????): THERMOPLASTIC LCP, UL94V-0(LCP??UL94V-0?,
 - 2.2. CENTER CONTACT: COPPER ALLOY C5191
 - 2.3. SHELL CONTACT(????): COPPER ALLOY C5191(??C5191?.

3



4

RECOMMENDED PCB LAYOUT
(TOLERANCE: ±0.05)

- CENTER CONTACT
- GROUND CONTACT

5

GENERAL TOLERANCE	DONGGUAN BAOXUN PRECISION TECHNOLOGY CO., LTD					
DIM. TOL.	TITLE: MICRO RF 1 BOARD SMT 4 PADS TYPE					
X ±0.30	DWG. NO.: IPEX-02				DRAWN: MAX	
X.X ±0.25	PART NO.: IPEX-02				CHECKED: ELLA	
X.XX ±0.15	UNIT: mm	SCALE: none	SHEET: 1 of 1	DWG. SIZE: A4	LAYER: bxconn	
X.XXX ±0.15	APPROVED: WILL					
GENERAL ANGLE: ±3°						